

UM10989

NTAG I2C Demo Android app Developer start-up guide

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User manual
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Document information

Info	Content
Keywords	NTAG I ² C, NTAG I ² C <i>plus</i> , Explorer Kit, Android, NFC tag
Abstract	This User Manual aims at describing the functionalities and how to start using NTAG I ² C <i>plus</i> Android application source code.



Revision history

Rev	Date	Description
1.0	20160316	First version

Contact information

For more information, please visit: <http://www.nxp.com>

1. Object

NTAG I²C Explorer kit is an all-in-one demonstration and development resource to demonstrate the unique properties of the NTAG I²C tag chip. By including a full complement of hardware and software tools, users can not only investigate the capabilities of the chip through the various demonstrations, but also develop and test their own applications.

This User Manual explains how to use the source code of NTAG I²C demo application for Android in Android Studio. Technical aspects related to the IC functioning (i.e. the configuration registers) are beyond the scope of this document. Source code is re-usable for NXP NTAG I²C (1K and 2K of user memory) and NTAG I²C *plus* (1K and 2K user memory) products. For detailed functionalities please take a look to dedicated datasheets [NTAGI2Cplus] and [NTAGI2C].

For use of this user manual, basic Android programming skills should be already obtained. Please follow www.nxp.com/redirect/developer.android.com/index.html webpage to get started.

2. Android studio import

Download and install latest instance of Android Studio (1.5.1 at the time of writing this document) from <http://nxp.com/external/android-ndefmessage>. Make sure you have the latest Android SDK installed. Since this app is only working with NFC enabled devices, AVD (Android Virtual Device) is not necessary for debugging. Download zipped source files from NXP website [link]. Extract the .zip to your local hard drive. Open Android studio. On the welcome screen select "Open an existing Android Studio project".

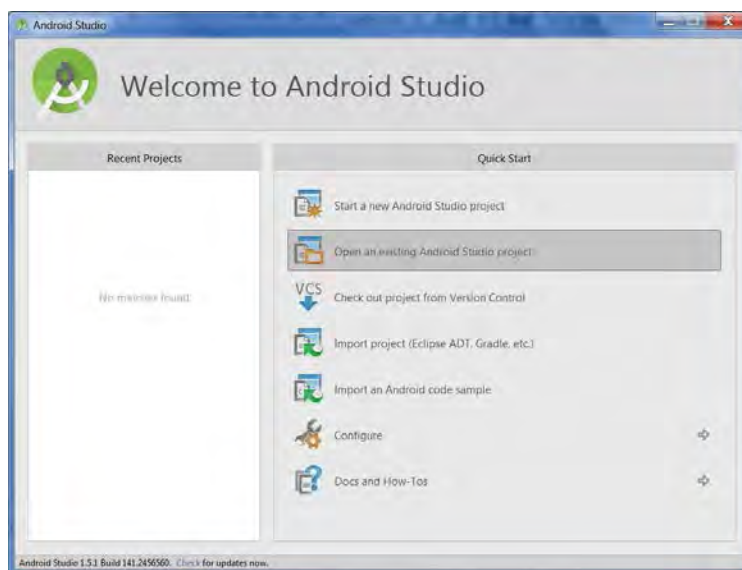


Fig 1. Android studio Welcome screen

Select the previously extracted source directory. Importing will start. Gradle synchronization will start – internet connection is needed. Project is loaded into Project pane.

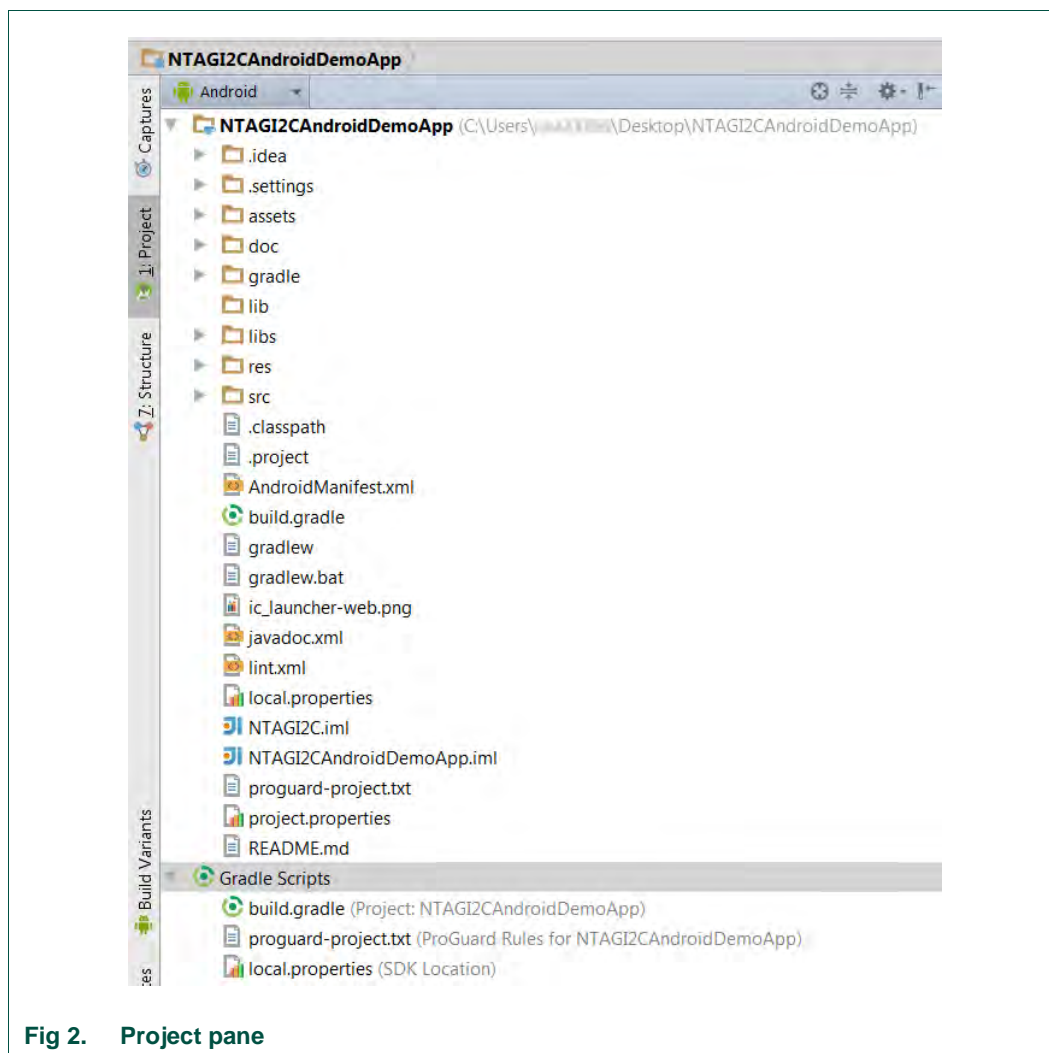


Fig 2. Project pane

2.1 Source code design

Application is using standard Android NFC API. It provides access to Near Field Communication (NFC) functionality. Classes and methods are implemented according NTAG I2C *plus* datasheet. External “ndeftools” library is used for easy manipulation of NDEFs.

3. NFC enabled Android Phone set-up for debugging

Debug mode should be “on” – under “Settings” go to “Developer options” Set “USB debugging to ON”. This will enable debugging on your phone. Connect phone via USB to your PC. Latest drivers for the phone being debugged should be installed (e.g. Nexus phones should have Google USB driver installed).

On some phones where “Debug mode” is not visible in “Settings” mode, find the “Build Number” under “Settings” → “About device”. Tap on the section 7 times. After few taps, a

small pop up notification should appear saying "you are now X steps away from being a developer" with a number that counts down with every additional tap.



Fig 3. Setting the USB debugging ON

In Android studio go to “Run” → “Edit Configurations...” Under “Deployment Target Options” select “USB Device”. Press “Apply” or “OK”.

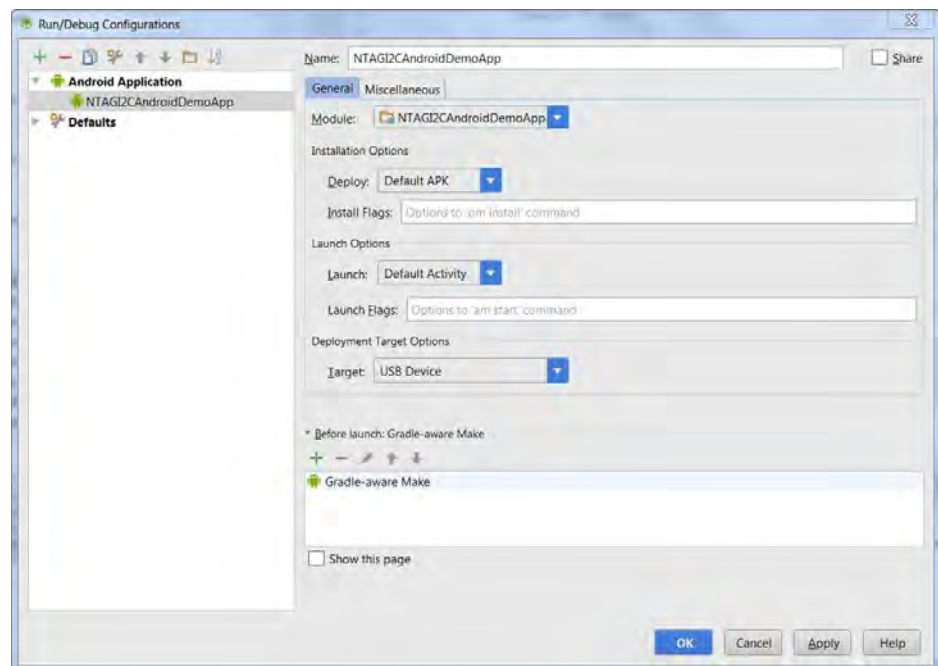


Fig 4. Run/Debug Configuration

Press “Run” [project name] “. App will be flashed to your USB plugged phone.
Debugging is started.

4. Special Methods for NTAG I2C *plus*

NTAG I2C *plus* has some special features like FAST_WRITE, Authentication, pass-through mode etc. Below are interesting parts of source code to show these capabilities. In this section brief explanation of specific methods are given. For easy searching through sources in Android Studio, “Search Everywhere” is implemented. With 2 tabs on the Shift Key dialog is popped-up. This way it is possible to quickly access the portion of the source code which is already imported.

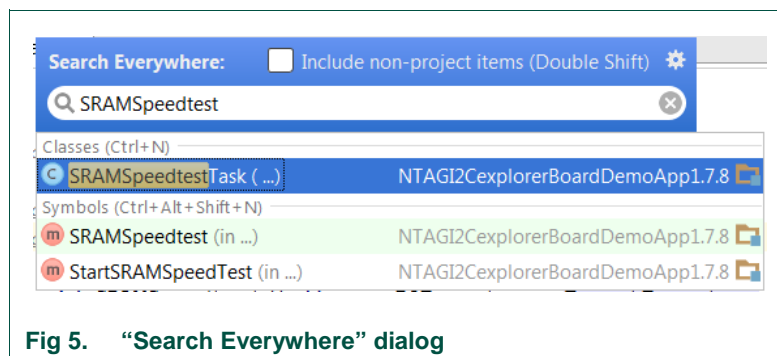


Fig 5. “Search Everywhere” dialog

In further instructions, search string will be provided to search over source code:

Search Everywhere (2 times Shift Key): Sample_Method

4.1 SRAM speed test

SRAM Speed Test writes 64 bytes (SRAM Size) as many times as requested by the user and then those bytes are read. The CRC32 is used to ensure the integrity of the data transmitted / received. In method “doInBackground” test is done. The last byte to read/write is marked by writing “finish_S_[byte]”. **Search Everywhere (2 times Shift Key): SRAMSpeedtestTask**

4.2 AUTHENTICATION

Access to NTAG I2C *plus* can be password protected. “ObtainAuthStatus”, together with “getProtectionPlus” method defined in “NTAG_I2C_Commands.java” and “Minimal_NTAG_Commands.java” return the protection status every time an IC is detected. Authentication request window is shown with three pre-defined passwords in case that NTAG I2C *plus* is PWD protected.

Search Everywhere (2 times Shift Key): ObtainAuthStatus

Method “Auth” returns password protection status of the tag. It is used when user taps on lock icon. Depending on the status of the tag user can choose:

- If the status is unprotected, user wants to protect the tag.

- If the tag is already authenticated, then we want to unprotect – remove authentication.
- If the tag is in protected status, then we want to authenticate to be able to complete the demos on password protected tags.

Search Everywhere (2 times Shift Key): Boolean Auth(

4.3 NFC MCU Firmware flash

Explorer kit in addition of NTAG I2C *plus* antenna board with the on-chip SRAM, permits temporary storage of data during the transfer, enabling the tag chip to act as a modem. Programming is performed by erase and write operation on the on-chip flash memory, as directed by the end-user application code. This is called an “In application programming” (IAP) which is supported by NXPs’ LPC11U24 MCU and special secondary bootloader. For details please see [\[UM10966\]](#).

The way how flash memory on MCU is organized, whole sectors of NTAG are flashed and the minimum size of data to write is pages. When flashing is done, MCU is informed about status of flashing process.

Search Everywhere (2 times Shift Key): Boolean Flash(

4.4 NDEF

Standard NDEF operations according to NDEF specifications are implemented.

4.4.1 NDEF Text Message method

New method can be declared by “createNdefMessage” type method with desired name to create a new NDEF text message. It is Android class.

Example:

```
NdefMessage msg = createNdefTextMessage("your text").
```

The NdefTextMessage Object is returned.

More resource on below link:

<http://nxp.com/external/android-ndefmessage>

Search Everywhere (2 times Shift Key): createNdefTextMessage(

4.4.2 NDEF URI Message method

New method can be declared by “createNdefUriMessage” type method with desired name to create a new NDEF URI message. It is Android class.

Example:

```
NdefMessage msg = createNdefUriMessage("your url").
```

The NdefUriMessage Object is returned.

More resource on below link:

<http://nxp.com/external/android-ndefmessage>

Search Everywhere (2 times Shift Key): createNdefUriMessage (

4.4.3 NDEF Bluetooth secure Simple Pairing Message method

New method can be declared by “createNdefBSPMessage” type method with desired name to create a bluetooth secure Simple Pairing Message. It is Android class.

Example:

```
NdefMessage msg = createNdefBSPMessage("");
```

The NdefBSPMessage Object is returned.

More resource on below link:

<http://nxp.com/external/android-ndefmessage>

Search Everywhere (2 times Shift Key): createNdefBSPMessage (

4.4.4 NDEF Smart Poster Message method

New method can be declared by “createNdefSpMessage” type method with a desired title and URI to create a NDEF SmartPoster Message. It is Android class.

Example:

```
NdefMessage msg = createNdefSpMessage ("").
```

The NdefSpMessage Object is returned.

More resource on below link:

<http://nxp.com/external/android-ndefmessage>

Search Everywhere (2 times Shift Key): createNdefSpMessage(

5. References

- [NTAGI2Cplus] NT3H2111/NT3H2211, NTAG I²C *plus*, NFC Forum Type 2 Tag compliant IC with I²C interface datasheet
http://www.nxp.com/documents/data_sheet/NT3H2111_2211.pdf
- [NTAGI2C] NT3H1101/NT3H1201, NTAG I²C, NFC Forum Type 2 Tag compliant IC with I²C interface datasheet
http://www.nxp.com/documents/data_sheet/NT3H1101_1201.pdf
- [NFCT2T] NFC Forum – Type 2 Tag Operation Ver. 1.2 Technical Specification
http://www.nxp.com/redirect/members.nfc-forum.org/specs/spec_list/
- [UM10966] NTAG I²C *plus* Explorer Kit and Android Demo user manual
http://nxp.com/documents/user_manual/UM10966.pdf

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